## Display Elektronik GmbH

# DATA SHEET

## **LCD MODULE**

## **DEM 240160B FGH-PW**

**Product Specification** 

**Ver.:** 1

### **DOCUMENT REVISION HISTORY**

Version	DATE	DESCRIPTION	CHANGED BY
00	Oct-30-2009	First issue	MH
01	Jan-13-2017	Updated dimensional outline at page 3.	МНО

## **CONTENTS**

1. Functions & Features	2
2. Mechanical specifications	2
3. Block diagram	2
4. Dimensional outline	3
5. Pin description	4
6. Maximum absolute limit	6
7. Electrical characteristics	6
8. Timing characteristics	7
9. Control and display command	9
10. Electro-Optical characteristics	11
11. Backlight characteristics	11
12. Precaution for using LCD/LCM	12

#### 1. FUNCTIONS & FEATURES

Format : 240\*160 Dots

LCD mode : FSTN /Positive Mode /Transflective

Viewing direction : 6 o'clock

Driving scheme : 1/160 Duty cycle, 1/12 Bias

Power supply voltage  $(V_{DD})$  : 3.3 Volt (typ.)

LCD driving voltage (VLCD) : 16.0 Volt (typ. Reference voltage)
Driver IC : UC1698u (Ultrachip) (or compatible)

Operation temp  $: -20^{\circ}\text{C to } +70^{\circ}\text{C}$ Storage temp  $: -30^{\circ}\text{C to } +80^{\circ}\text{C}$ 

Back light : LED, White, Lightguide, 7 LEDs

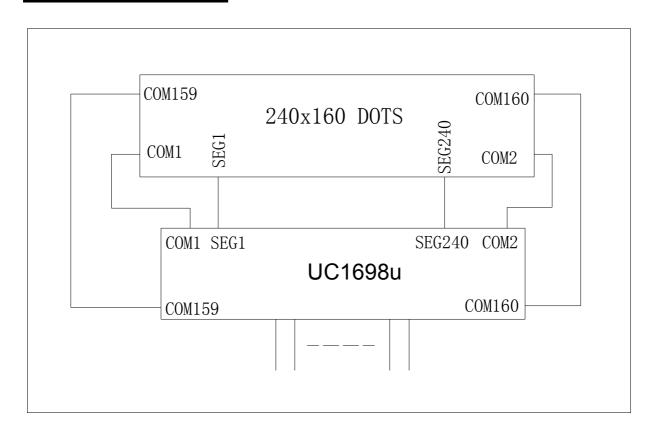
RoHS : Compliant.

#### 2. MECHANICAL SPECIFICATIONS

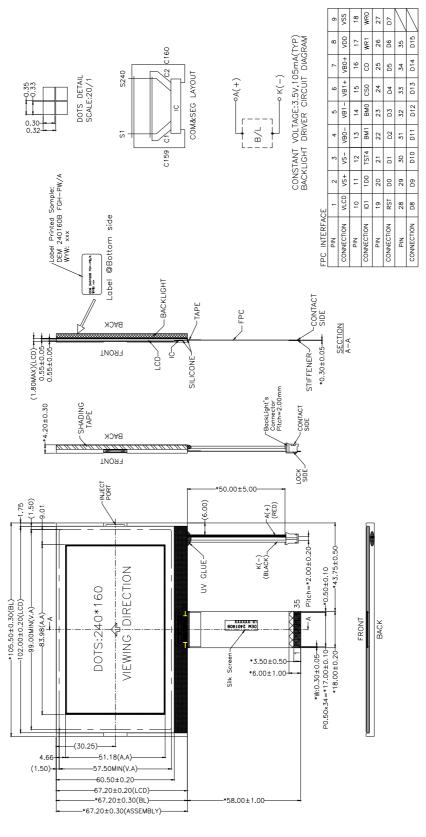
Module size : 105.50 x 67.20 x 4.20 mm Viewing area : 99.00 x 57.50 mm

Dot pitch  $0.35 \times 0.32 \text{ mm}$  Dot size  $0.33 \times 0.30 \text{ mm}$ 

#### 3. BLOCK DIAGRAM



#### **4. DIMENSIONAL OUTLINE**



## **5. PIN DESCRIPTION**

1	VLCD	Power suppl	y for LCD voltage	e								
	VS+, VS-,											
2~7	VB0-, VB1-,	LCD SEG d	riving voltages.									
	VB1+, VB0+											
8	VDD	Power suppl	y for logic(+3.3V	()								
9	VSS	Ground										
	ID1	Selects Inpu	t Data set for 8-bit	mode.								
10			it input data are D it input data are D	[0,2,4,6,8,10,12,14] [0:7]								
10				available in PID[1:0] with command e, connect ID1 to V <sub>DD</sub> for "H", or V <sub>SS</sub>								
11	ID0	ID0 pin can	D0 pin can be used for production control.									
11		Connect ID0	) pin to $V_{DD}$ for "H"	or V <sub>SS</sub> for "L".								
	TST4		Test control. This pin has on-chip pull-up resistor. Leave it open during normal operation.									
12		programmin	TST4 is also used as one of the high voltage power supply for MTP programming operation. For COG designs, please wire out TST4 with trace resistance between $30\sim50~\Omega$ .									
			The interface bus    3} by the following	mode is determined by BM[1:0] and g relationship:	I							
		BM[1:0]	{DB15, DB13}	Mode								
		11	Data	6800/16-bit								
		10	Data	8080/16-bit								
		01	0x	6800/8-bit								
13,14	BM1, BM0	00	0x	8080/8-bit								
		00	10	4-wire SPI w/ 8-bit token (S8: conventional)								
		00	11	3/4-wire SPI w/ 8-bit token (S8uc: Ultra-Compact)								
		01	3-wire SPLw/ 9-hit taken									
15	CS0	Chip select s	signal									
16	CD	Selects Control data or Display data for read/write operation. In S9 mode, CD pin is not used. Connect to V <sub>SS</sub> when not used.										
10		"L": Contro		": Display data								

		WR[1:0] contri section <i>Host I</i>				host interface	e. See				
17,18	WR1 ,WR0	In parallel mod interface is in modes, these	the 6800 m	ode or the	8080 mode	e. In serial inte					
19	RST	The RESET s	signal								
		Bi-directional	bus for par	allel host in	iterfaces.						
		In serial mode	s, connect	DB[0] to S	CK, DB[8]	to SDA.					
			BM=1x	BM=0x	BM=0x	BM=00	BM=01				
			(16-bit)	(8-bit) ID1=0	(8-bit) ID1=1	(S8/S8uc)	(S9)				
		DB0	D0	D0/D8	D0/D8	SCK	SCK				
		DB1	D1	_	D1/D9	_	_				
		DB2	D2	D1/D9	D2/D10	_	-				
		DB3	D3	_	D3/D11	_	_				
						DB4	D4	D2/D10	D4/D12	_	_
		DB5	D5	_	D5/D13	_	_				
20~35	D0~D15	DB6	D6	D3/D11	D6/D14	_	_				
		DB7	D7	_	D7/D15	_	_				
		DB8	D8	D4/D12	_	SDA	SDA				
		DB9	D9	_	-	_	_				
		DB10	D10	D5/D13	-	_	_				
		DB11	D11	_	-	_	_				
		DB12	D12	D6/D14	_	_	_				
		DB13	D13	_	-	0:S8/1:S8uc	0				
		DB14	D14	D7/D15	_	_	_				
		DB15	D15	0	0	1	1				
		Always conne	ct unused	pins to eith	er V <sub>SS</sub> or V	DD.					

### **6. MAXIMUM ABSOUTE LIMIT**

Maximum Ratings (Voltage Reference to VSS)(for IC)

#### **ABSOLUTE MAXIMUM RATINGS**

In accordance with IEC134, Note 1 and 2

Symbol	Parameter	Min.	Max.	Unit
$V_{DD}$	Logic Supply voltage	-0.3	+4.0	V
$V_{DD2}$	LCD Generator Supply voltage	-0.3	+4.0	V
V <sub>DD3</sub>	Analog Circuit Supply voltage	-0.3	+4.0	V
$V_{DD2/3}$ - $V_{DD}$	Voltage difference between $V_{\text{DD}}$ and $V_{\text{DD2/3}}$		1.6	V
$V_{LCD}$	LCD Driving voltage (-25°C ~ +75°C)	-0.3	+19.8	V
$V_{IN}$	Digital input signal	-0.4	$V_{DD} + 0.5$	V
T <sub>OPR</sub>	Operating temperature range	-30	+85	°C
T <sub>STR</sub>	Storage temperature	-55	+125	°C

#### NOTE:

- 1.  $V_{DD}$  is based on  $V_{SS} = 0V$
- 2. Stress beyond ranges listed above may cause permanent damages to the device.

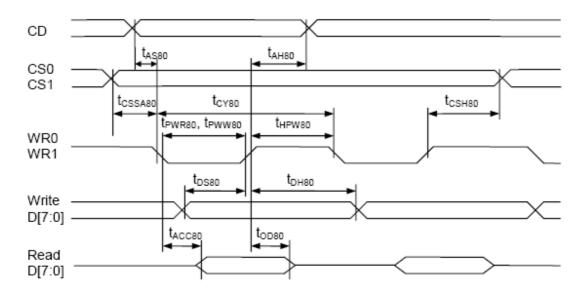
### 7. ELECTRICAL CHARACTERISTICS

#### DC CHARACTERISTICS

#### DC CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply for digital circuit		1.65		3.3	٧
V <sub>DD2/3</sub>	Supply for bias & pump		2.7		3.3	٧
$V_{LCD}$	Charge pump output	V <sub>DD2/3</sub> = 2.8V, 25 <sup>o</sup> C		15.2	18	٧
VD	LCD data voltage	$V_{DD2/3} = 2.8V, 25^{\circ}C$	1.09		1.95	٧
$V_{IL}$	Input logic LOW				$0.2 V_{\text{DD}}$	V
$V_{IH}$	Input logic HIGH		$0.8V_{DD}$			V
Vol	Output logic LOW				$0.2 V_{\text{DD}}$	V
Voн	Output logic HIGH		$0.8V_{DD}$			V
I <sub>IL</sub>	Input leakage current				1.5	μΑ
I <sub>SB</sub>	Standby current	$V_{DD} = V_{DD2/3} = 3.3V$ , Temp = 85°C			50	μΑ
C <sub>IN</sub>	Input capacitance			5	10	PF
C <sub>OUT</sub>	Output capacitance			5	10	PF
Ron(SEG)	SEG output impedance	V <sub>LCD</sub> = 16.5V		850	1100	Ω
R <sub>ON(COM)</sub>	COM output impedance	V <sub>LCD</sub> = 16.5V		950	1100	Ω
f <sub>LINE</sub>	Average line rate	LC[4:3] = 10b, 25°C	-10%	37.0	+10%	Klps

## **8. TIMING CHARACTERISTICS**

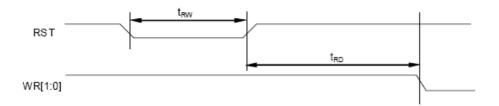


Parallel Bus Timing Characteristics (for 8080 MCU)

 $(2.5V \le V_{DD} < 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$ 

Symbol	Signal	Description	Condition	Min.	Max.	Units
t <sub>AS80</sub>	CD	Address setup time		0	-	nS
t <sub>AH80</sub>		Address hold time		0		
t <sub>CY80</sub>		System cycle time 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	170 130 100 80 90	1	nS
t <sub>PWR80</sub>	WR1	Pulse width 16-bit (read) 8-bit		85 50	ı	nS
t <sub>PWW80</sub>	WR0	Pulse width 16-bit (write) 8-bit	LC[7:6]=10b LC[7:6]=01b	65 40 45	1	nS
t <sub>HPW80</sub>	WR0, WR1	High pulse width 16-bit bus (read) (write) 8-bit bus (read) (write)	LC[7:6]=10b LC[7:6]=01b	85 65 50 40 45	-	nS
t <sub>DS80</sub> t <sub>DH80</sub>	D0~D15	Data setup time Data hold time		30 0	-	nS
t <sub>ACC80</sub> t <sub>OD80</sub>		Read access time Output disable time	C <sub>L</sub> = 100pF	- 15	60 30	nS
T <sub>CSSA80</sub> t <sub>CSH80</sub>	CS1/CS0	Chip select setup time		5 5		nS

#### **RESET TIMING**



Reset Characteristics

 $(1.65V \le V_{DD} < 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$ 

Symbol	Signal	Description	Condition	Min.	Max.	Units
t <sub>RW</sub>	RST	Reset low pulse width		3	-	μS
t <sub>RD</sub>	RST, WR	Reset to WR pulse delay		10	_	mS

## 9. CONTROL AND DISPLAY INSTRUCTION The following is a list of host commands supported by UC1698u

C/D: 0: Control, 1: Data

W/R: 0: Write Cycle, 1: Read Cycle

#: Useful Data bits —: Don't Care

	#. Oseitii Data bits	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Actio	n	Default
1	Write Data Byte	1	0	#	#	#	#	#	#	#	#	Write 1		N/A
2	Read Data Byte	1	1	#	#	#	#	#	#	#	#	Read 1		N/A
-	Read Data Dyte		'	GE	MX	MY	WA	DE.	WS	MD	MS	Get {Statu		IN//
3	Get Status & PM	0	1	Ver	IVIX	IVII		MO[6:		IVID	IVIO	PMO, Produ	ct Code	N/A
ľ	oct otatao a i m		١.		duct (	Code (		PID		MID	[1:0]	PID, M		1473
Н	Set Column Address LSB	0	0	0	0	0	0	#	#	#	#	Set CA		0
4	Set Column Address MSB	0	0	0	0	0	1	0	#	#	#	Set CA		0
5	Set Temp. Compensation	0	0	0	0	1	0	0	1	#	#	Set TC		0
6	Set Power Control	0	0	0	0	1	0	1	0	#	#	Set PC		10b
7	Set Adv. Program Control	0	0	0	0	1	1	0	0	0	R	Set APC[F		NI/A
l ′ l	(double-byte command)	0	0	#	#	#	#	#	#	#	#	R = 0 o		N/A
	Set Scroll Line LSB	0	0	0	1	0	0	#	#	#	#	Set SL[	3:0]	0
8	Set Scroll Line MSB	0	0	0	1	0	1	#	#	#	#	Set SL		0
9	Set Row Address LSB	0	0	0	1	1	0	#	#	#	#	Set RA		0
Э	Set Row Address MSB	0	0	0	1	1	1	#	#	#	#	Set RA	7:4]	0
10	Set V <sub>BIAS</sub> Potentiometer	0	0	1	0	0	0	0	0	0	1	Set PM[	7:01	40H
	(double-byte command)	0	0	#	#	#	#	#	#	#	#		-	
11	Set Partial Display Control	0	0	1	0	0	0	0	1	0	#	Set LC		0
12	Set RAM Address Control	0	0	1	0	0	0	1	#	#	#	Set AC[	2:0]	001b
13	Set Fixed Lines	0	0	1	0	0	1	0	0	0	0	Set (FLT,	FLB}	0
ш		0	0	#	#	#	#	#	#	#	#	•	-	
14	Set Line Rate	0	0	1	0	1	0	0	0	#	#	Set LC[		10b
15	Set All-Pixel-ON	0	0	1	0	1	0	0	1	0	#	Set DC		0
	Set Inverse Display	0	0	1	0	1	0	0	1 #	1 #	#	Set DC		0
17	Set LCD Manning Control	0	0	1	1	0	0	0	#	#	#	Set DC[		110b 0
18	Set LCD Mapping Control	U	U	1	1	0	0	1	0	0	0	Set LC[	Z.UJ	U
19	Set N-Line Inversion	0	0	-		-	#	#	#	#	#	Set NIV	[4:0]	1DH
20	Set Color Pattern	0	0	1	1	0	1	0	0	0	#	Set LC	[5]	0 (BGR)
21	Set Color Mode	0	0	1	1	0	1	0	1	#	#	Set LC[		10b
22	Set COM Scan Function	0	0	1	1	0	1	1	#	#	#	Set CSF		000b
23	System Reset	0	0	1	1	1	0	0	0	1	0	System F		N/A
24	NOP	0	0	1	1	1	0	0	0	1	1	No oper		N/A
25	Set Test Control	0	0	1	1	1	0	0	1	<u> </u>	I	For testing		N/A
	(double-byte command)	0	0	#	#	#	#	#	#	#	#	Do not		
26	Set LCD Bias Ratio	0	0	11	1	1	0	1	0	#	#	Set BR	1:0]	11b: 12
27	Set COM End	0 0	0	1	1 #	1 #	1 #	0	0	0	1 #	Set CEN	I[6:0]	159
Н		0	0	1	1	1	1	0	0	1	0			
28	Set Partial Display Start	0	0	<u>'</u>	#	#	#	#	#	#	#	Set DST	[6:0]	0
-		0	0	1	1	1	1	0	0	1	1			
29	Set Partial Display End	ő	0	_	#	#	#	#	#	#	#	Set DEN	l[6:0]	159
30	Set Window Program Starting Column Address	0	0	1	1 #	1 #	1 #	0	1 #	0	0		Set WPC0	0
2.4	Set Window Program	0	0	1	1	1	1	0	1	0	1		Set	
31	Starting Row Address	ŏ	0	#	#	#	#	#	#	#	#	Shared	WPP0	0
32	Set Window Program	0	0	1	1	1	1	0	1	1	0	with MTP commands	Set	127
32	Ending Column Address	0	0	-	#	#	#	#	#	#	#	Commands	WPC1	121
33	Set Window Program	0	0	1	1	1	1	0	1	1	1	Se		159
	Ending Row Address	0	0	#	#	#	#	#	#	#	#			
34	Window Program Mode	0	0	1	1	1	1	1	0	0	#	Set AC	[3]	0: Inside
35	Set MTP Operation control	0	0 0	1	0	1	1 #	1 #	0	0	0	Set MTP	C[4:0]	10H
ш	-	U	U		_	_	#	#	#	#	#			

	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Actio	n	Default
36	Set MTP Write Mask	0	000	1 - -	0 # -	1 # -	1 # -	1 # -	0 # -	0 # #	1 # #	Set MTPM MTPM1		0
37	Set V <sub>MTP1</sub> Potentiometer	0	0	1	1	1 #	1 #	0 #	1 #	0 #	0 #		Set MTP1	N/A
38	Set V <sub>MTP2</sub> Potentiometer	0	0	1	1 #	1 #	1 #	0 #	1 #	0 #	1 #	Shared with Window Program commands	Set MTP2	N/A
39	Set MTP Write Timer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	0 #		Set MTP3	N/A
40	Set MTP Read Timer	0	0	1 #	1 #	1 #	1 #	0 #	1 #	1 #	1 #		Set MTP4	N/A

#### Note:

- All other bit patterns other than commands listed above may result in undefined behavior.
- . The interpretation of commands (36)~(40) depends on the setting of register MTPC[3].
  - Commands (37)~(40) are shared with commands (30)~(33). These two sets of commands share exactly the same code and control registers. When MTPC[3]=0, they are interpreted as Window Program commands and registers. When MTPC[3]=1, they function as MTP Control commands and registers.
- · After MTP ERASE or PROGRAM operation, before resuming normal operation, please always
  - a) Remove TST4 power source,
  - b) Do a full V<sub>DD</sub> ON-OFF-ON cycle.
- Under 16-bit bus mode and CD=0, D[15:8] is ignored and only D[7:0] is used. As a result, the bus cycles
  for commands under 16-bit bus and 8-bit bus are the same, and double-byte commands still need two
  bus cycles under 16-bit bus mode.

#### Example:

#### 8-bit bus mode:

Set PL[1:0] = 2'b11 : D[7:0] =  $0010 \ 1011$ Set PM[7:0] = 8'h8b : 1<sup>st</sup> D[7:0] =  $1000 \ 0001$  $2^{nd}$  D[7:0] =  $1000 \ 1011$ 

#### 16-bit bus mode:

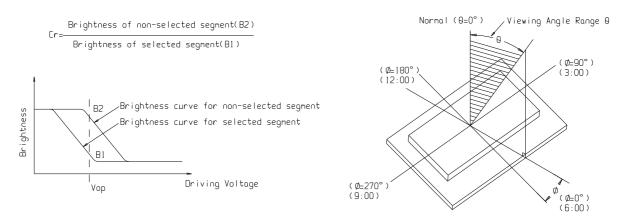
Set PL[1:0] = 2'b11: D[15:0] =  $\boxed{0000\ 0000} \quad 0010\ 1011$ Set PM[7:0] = 8'h8b: 1<sup>st</sup> D[15:0] =  $\boxed{0000\ 0000} \quad 1000\ 0001$  $2^{nd}$  D[15:0] =  $\boxed{0000\ 0000} \quad 1000\ 1011$ 

#### 10. ELECTRO-OPTICAL CHARACTERISTICS

 $(V_{DD} = 3.3V, Ta = 25^{\circ}C)$ 

Item	Symbol	Condition	Min	Тур	Max	Unit
On anoting Waltage		$Ta = -20^{\circ}C$	16.2	16.5	16.8	
Operating Voltage for LCD	Vop	$Ta = 25^{\circ}C$	15.7	16.0	16.3	V
		$Ta = 70^{\circ}C$	15.2	15.5	15.8	
Dagagagatina	Tr	Ta = 25°C		250	500	ms
Response time	Tf	1a-25 C		300	600	ms
Contrast	Cr	$Ta = 25^{\circ}C$	2	4		
Viewing angle range	θ	Cr≥2	-35		+35	deg
viewing angle range	Ф	C1 <u>~</u> 2	-35		+40	deg

The following charts is for your reference of the data in the above form.



#### 11. BACK LIGHT CHARACTERISTICS

LCD Module with edge LED Backlight. Electrical ratings. Ta = 25°C

Item	Symbol	Condition	Min	Тур	Max	Unit				
Forward Current	IF	VF=3.5V		105	140	mA				
Reverse Current	IR	VR=5.0V			70	uA				
Luminous Intensity (With LCD dots off)	Lv	VF=3.5V	250	300		cd/m <sup>2</sup>				
Wave length	λρ	VF=3.5V	X=0.26 Y=0.26		X=0.30 Y=0.30					
Color		white								

#### Note:

when the temperature exceed 25°C, the approved current decrease rate for Backlight change as the temperature increase is: -0.36\*7mA/°C (below 25°C, the current refer to constant, which would not change with temperature ).

#### 12. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours (average) under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

#### Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting DISPLAY.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

#### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 350°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### **Limited Warranty**

DISPLAY LCDs and modules are not consumer products, but may be incorporated by DISPLAY 's customers into consumer products or components thereof, DISPLAY does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of DISPLAY is limited to repair or replacement on the terms set forth below. DISPLAY will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between DISPLAY and the customer, DISPLAY will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with DISPLAY general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.